

## Surface-Mount Ultrafast Plastic Rectifier


**SMC (DO-214AB)**

 Cathode  —  Anode

### LINKS TO ADDITIONAL RESOURCES


[3D Models](#)

PRIMARY CHARACTERISTICS	
$I_{F(AV)}$	3.0 A
$V_{RRM}$	100 V, 150 V, 200 V
$I_{FSM}$	100 A
$t_{rr}$	20 ns
$V_F$ at $I_F = 3.0$ A	0.74 V
$T_J$ max.	150 °C
Package	SMC (DO-214AB)
Circuit configuration	Single

### FEATURES

- Oxide planar chip junction
- Ultrafast recovery time
- Low forward voltage, low power losses
- High forward surge capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)


**RoHS**  
 COMPLIANT  
 HALOGEN  
**FREE**

### TYPICAL APPLICATIONS

For us in high frequency rectification and freewheeling application in switching mode converters and inverters for consumer, computer, automotive and telecommunication.

### MECHANICAL DATA

**Case:** SMC (DO-214AB)

Molding compound meets UL 94 V-0 flammability rating  
 Base P/N-E3 - RoHS-compliant, commercial grade  
 Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

**Terminals:** matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

E3 and M3 suffix meets JESD 201 class 2 whisker test

**Polarity:** color band denotes cathode end

MAXIMUM RATINGS ( $T_A = 25$ °C unless otherwise noted)						
PARAMETER	SYMBOL	U3B	U3C	U3D	UNIT	
Device marking code		U3B	U3C	U3D		
Maximum repetitive peak reverse voltage	$V_{RRM}$	100	150	200	V	
Maximum average forward rectified current (fig. 1)	$T_M = 134$ °C	$I_{F(AV)}^{(1)}$	2.0		A	
	$T_M = 125$ °C	$I_{F(AV)}^{(2)}$	3.0			
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	$I_{FSM}$	100		A		
Operating junction and storage temperature range	$T_J, T_{STG}$	-55 to +150		°C		

#### Notes

(1) Free air, mounted on recommended copper pad area

(2) Units mounted on PCB with 0.47" x 0.47" (12 mm x 12 mm) copper pad areas



ELECTRICAL CHARACTERISTICS ( $T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	$I_F = 3.0\text{ A}$	$T_A = 25\text{ }^\circ\text{C}$	$V_F^{(1)}$	0.85	0.90	V
		$T_A = 100\text{ }^\circ\text{C}$		0.74	0.83	
Reverse current	Rated $V_R$	$T_A = 25\text{ }^\circ\text{C}$	$I_R^{(2)}$	-	10	$\mu\text{A}$
		$T_A = 100\text{ }^\circ\text{C}$		250	500	
Reverse recovery time	$I_F = 0.5\text{ A}$ , $I_R = 1.0\text{ A}$ , $I_{rr} = 0.25\text{ A}$	$T_A = 25\text{ }^\circ\text{C}$	$t_{rr}$	-	20	ns
		$T_A = 25\text{ }^\circ\text{C}$		25	30	
		$T_A = 100\text{ }^\circ\text{C}$		35	50	
Storage charge	$I_F = 3.0\text{ A}$ , $dI/dt = 50\text{ A}/\mu\text{s}$ , $V_R = 30\text{ V}$ , $I_{rr} = 0.1\text{ I}_{RM}$	$T_A = 25\text{ }^\circ\text{C}$	$Q_{rr}$	9	15	nC
		$T_A = 100\text{ }^\circ\text{C}$		22	35	
Typical junction capacitance	4.0 V, 1 MHz		$C_J$	25	-	pF

**Notes**

- (1) Pulse test: 300  $\mu\text{s}$  pulse width, 1 % duty cycle  
(2) Pulse test: Pulse width  $\leq 40\text{ ms}$

THERMAL CHARACTERISTICS ( $T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)					
PARAMETER	SYMBOL	U3B	U3C	U3D	UNIT
Typical thermal resistance	$R_{\theta JA}^{(1)}$	92			$^\circ\text{C}/\text{W}$
	$R_{\theta JM}^{(1)}$	10			

**Note**

- (1) Free air, mounted on recommended copper pad area. Thermal resistance  $R_{\theta JA}$  - junction to ambient,  $R_{\theta JM}$  - junction to mount

ORDERING INFORMATION (Example)				
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
U3D-E3/57T	0.239	57T	850	7" diameter plastic tape and reel
U3D-E3/9AT	0.239	9AT	3500	13" diameter plastic tape and reel
U3D-M3/57T	0.239	57T	850	7" diameter plastic tape and reel
U3D-M3/9AT	0.239	9AT	3500	13" diameter plastic tape and reel

**RATINGS AND CHARACTERISTICS CURVES** ( $T_A = 25\text{ }^\circ\text{C}$  unless otherwise noted)

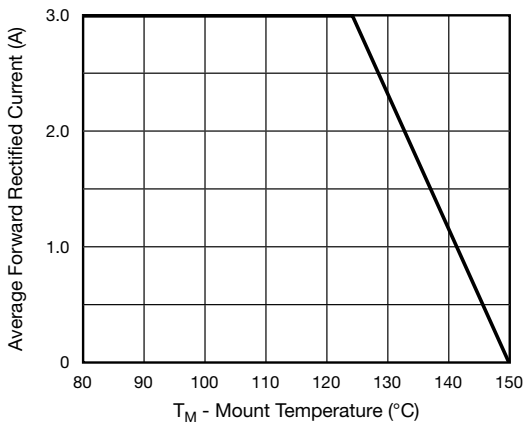


Fig. 1 - Maximum Forward Current Derating Curve

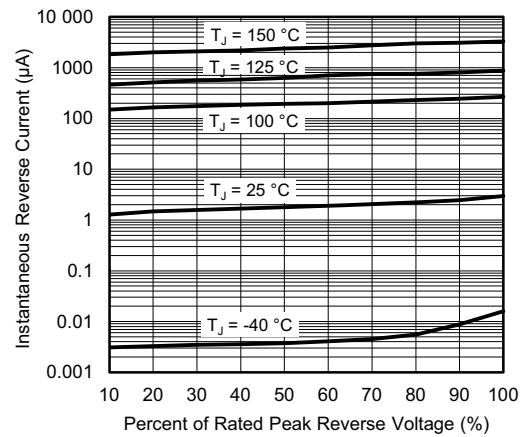


Fig. 4 - Typical Reverse Leakage Characteristics

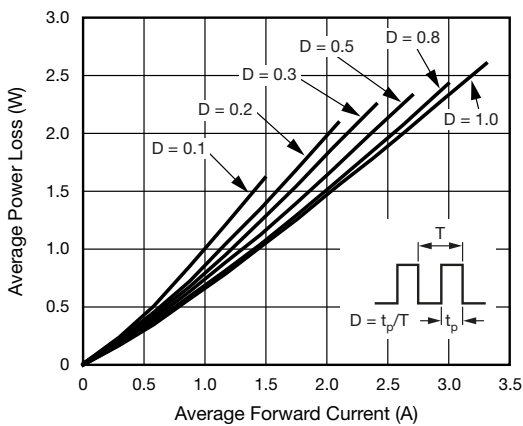


Fig. 2 - Forward Power Loss Characteristics

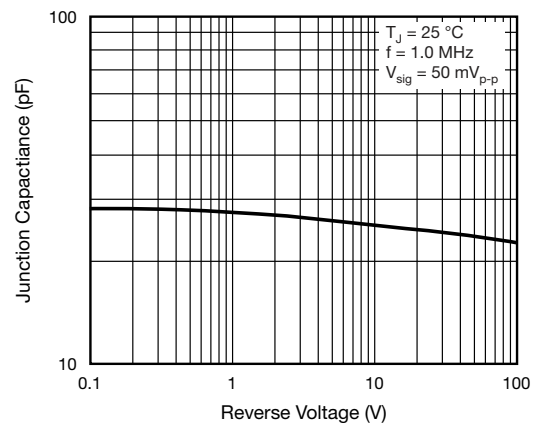


Fig. 5 - Typical Junction Capacitance

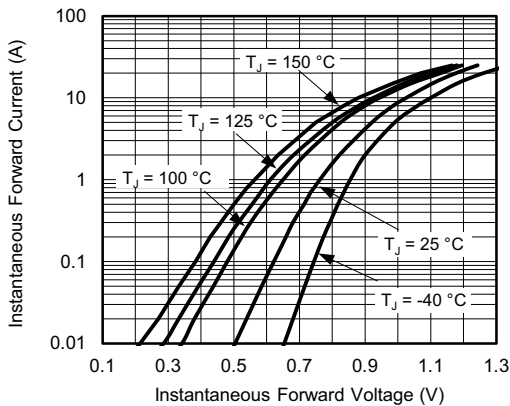


Fig. 3 - Typical Instantaneous Forward Characteristics

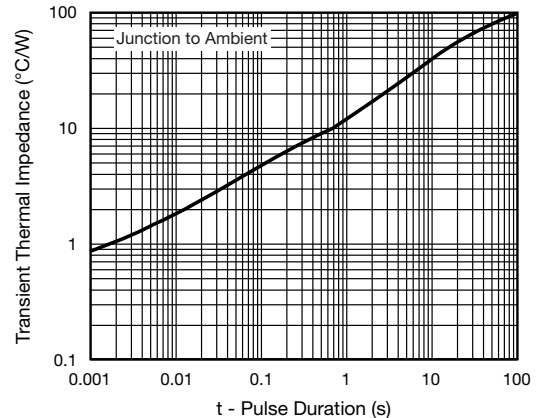
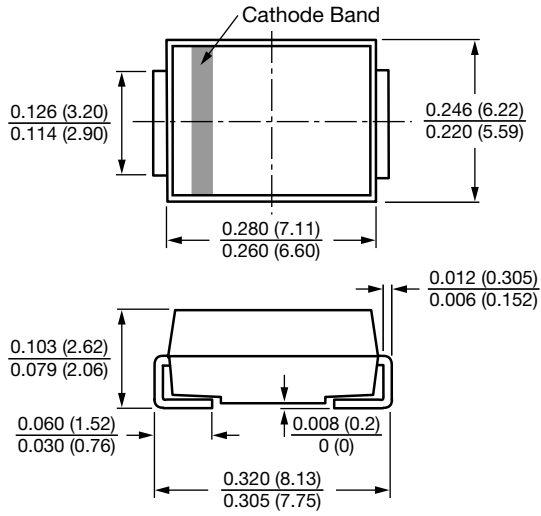


Fig. 6 - Typical Transient Thermal Impedance

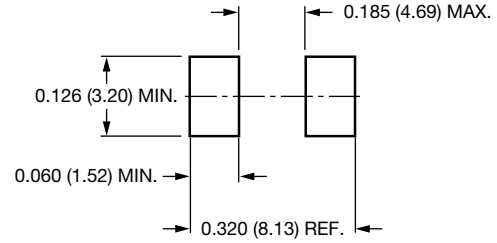


PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

SMC (DO-214AB)



Mounting Pad Layout





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